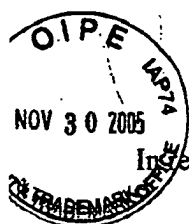


LPW



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Chad A. Cobbley et al.

Prior Application Serial No.: ~~10/672,750~~

Prior Application Filed:
September 25, 2003

Serial No.: 10/770,919

Filed: February 3, 2004

For: STACKED DIE MODULE AND
TECHNIQUES FOR FORMING A
STACKED DIE MODULE

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§ Group Art Unit: 2813
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§ Examiner: Blum, David S.
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§ Atty Docket: MICS:0078—5 (FLE)
§ (01-0752.005)
§

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CERTIFICATE OF MAILING 37 C.F.R. 1.8	
I hereby certify that this correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date below:	
November 28, 2005	
Date	Robert A. Manware

Sir:

RESPONSE TO OFFICE ACTION MAILED OCTOBER 27, 2005

In response to the Office Action mailed October 27, 2005, please amend the above-identified application as follows: